

FSL-3216050B-EATNNMC

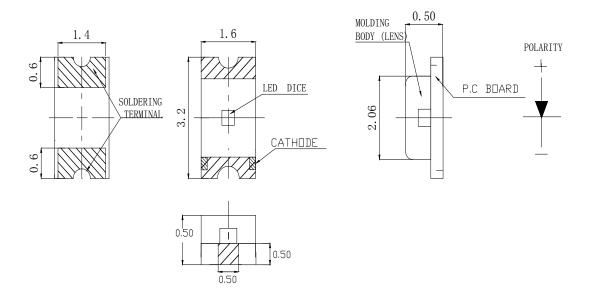
Features

- · 3.2mm*1.6mm SMT LED, Super thin (0.50H mm)
- · Low Power Consumption
- · Wide Viewing Angle
- · Various Colors
- · Compatible with automatic placement equipment.
- · Compatible with infrared and vapor phase reflow and wave solder process.
- · Meet ROHS Green Product
- · Package: 3000pcs/Reel

Applications

· Backlight and Indicator

Package Dimensions



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.2 mm(.0079") unless otherwise noted.
- 3. Specifications are subject to change without notice
- 4. This drawing is only for reference, not as a basis for the actual structure.

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Selection Guide

Part No	Lens Type	Dice	Emitted Color
FSL-3216050B-EATNNMC	Water Clear	InGaN	Blue

Electrical / Optical Characteristics At Ta=25 °C

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Iv	Luminous Intensity		180		mcd	IF=20mA
201/2	Viewing Angle		130		deg	IF=20mA
入 Peak	Peak Emission Wavelength		468		nm	IF=20mA
入 d	Dominant Wavelength	465	470	475	nm	IF=20mA
Δλ	Spectral Line Half-Width		25		nm	IF=20mA
VF	Forward Voltage	2.80	3.10	3.60	V	IF=20mA

Note:

Absolute Maximum Ratings At Ta=25℃

Parameter	Blue	Unit	
Power Dissipation	76	mW	
Peak Forward Current[1]	100	mA	
Continuous Forward Current	20	mA	
Derating Linear From 25 ℃	0.25	mA/°C	
Reverse Voltage	5	V	
Electrostatic Discharge Threshold (HBM)	300	V	
Operating Temperature Range	-20°C to + 80°C		
Storage Temperature Range	-30°C to + 100°C		
Soldering Condition	260℃ For 5 Seconds		

Note:

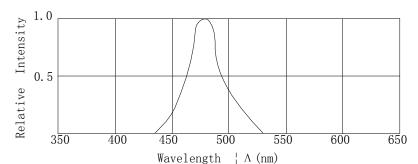
1. 1/10DutyCycle, 0.1msPulseWidth

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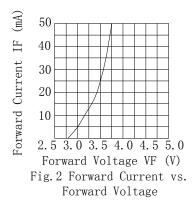
^{1.} θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 optical centerline value

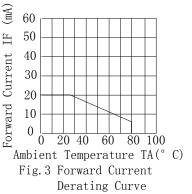


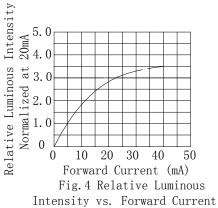
Electrical Optical Characteristics Curves At Ta=25 °C



VS. Wavelength Relative Intensity







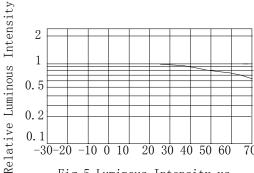


Fig. 5 Luminous Intensity vs. Ambient Temperature

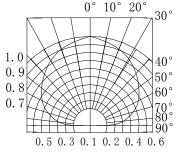


Fig. 6 Spatial Distribution

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Bin Range Of Luminous Intensity

Symbol	Bin Code	Min.	Max.	Unit	Condition
	P	45	72	mcd IF	
T	Q	72	112		IF=20mA
Iv	R	112	180		IF=20IIIA
	S	180	280		

Bin Range Of Forward Voltage

Symbol	Bin Code	Min.	Max.	Unit	Condition
	V1	2.80	3.00	V	IF=20mA
VF	V2	3.00	3.20		
VF	V3	3.20	3.40		
	V4	3.40	3.60		

Bin Range Of Dominate Wavelength

Symbol	Bin Code	Min.	Max.	Unit	Condition
) 1	A	465	470	nm	In 20m A
∧ d	В	470	475		IF=20mA

Notes:

- 1. Tolerance of Luminous Intensity +/-15%
- 2. Tolerance of Forward Voltage $\pm -0.1V$
- 3. Tolerance of the Dominate Wavelength +/- 2nm

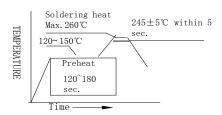
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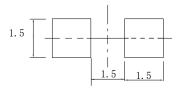
SMT Reflow Soldering Instructions



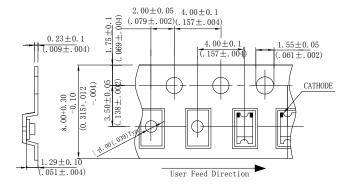
Notes:

- Selles gives no other assurances regarding the ability of to withstand ESD. It is recommended to use a
 wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must
 be properly grounded.
- 2. Reflow soldering should not be done more than two times.
- 3. Do not stress LED when soldering, and do not warp the circuit board after soldering
- 4. While using Iron, Power dissipation of Iron should be smaller than 25W, and temperature should be controllable. The work should be finished within 2 sec under 320°C for once only.

Recommended Soldering Pad Dimensions



Package Specifications (Units: mm(inches))



Notes:

- 1. The LEDs should be used within a year.
- 2. The LEDs should be kept in $5\sim30^{\circ}$ C and 60% RH for less.
- 3. The LEDs should be used within 24 hours, or else should be kept a 5~30°C and 30% RH or less. And LEDs should be used within 7 days after opening the package.

Date:

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Reliability Test Items Conditions

Classification	Test Item	Test Conditions	Test hours	Result
	Operation Life	Connect with a power IF=20mA Ta=Under room temperature	1000Hrs	0/20
F 1	High Temperature High Humidity	Ta=+65°C±5°C RH=90%-95%	240Hrs	0/20
Endurance Test	High Temperature Storage	High Ta=+85°C±5°C	1000Hrs	0/20
	Low Temperature Storage	Low Ta=-35°C±5°C Test time=1000hrs	1000Hrs	0/20
Temperature Cycling		-45°C ~+105°C 15min 5min 15min	300 Cycles	0/20
Environmental	Thermal Shock	-35°C ~±5°C ~+85°C ~±5°C 5min 10sec 5min	300 Cycles	0/20
Test	Solder Resistance	Preheating: 120°C-150°C, within 2 minutes. Operation heating: 260°C (Max.), within 5 seconds (Max.)	5Cycles	0/20

Judgment criteria of failure for the reliability

Measuring items	Symbol	Measuring conditions	Judgment criteria for failure
Forward voltage	V _F (V)	IF=20mA	Over U×1.2
Luminous intensity	Iv(mcd)	I _F =20mA	Below S×0.5

Note: 1.U means the upper limit of specified characteristics. S means initial value.

2.Meansurment shall be taken between 2 hours after the test pieces have been returned to normal ambient conditions after completion of each test.

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